

# INTERNATIONAL STANDARD

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**Semiconductor devices –  
Part 5-6: Optoelectronic devices – Light emitting diodes**





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**Semiconductor devices –  
Part 5-6: Optoelectronic devices – Light emitting diodes**

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# INTERNATIONAL ELECTROTECHNICAL COMMISSION

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## SEMICONDUCTOR DEVICES –

### Part 5-6: Optoelectronic devices – Light emitting diodes

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IEC 60747-5-6 has been prepared by subcommittee 47E: Discrete semiconductor devices, of IEC technical committee 47: Semiconductor devices. It is an International Standard.

This second edition cancels and replaces the first edition published in 2016. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) ultraviolet-emitting diodes (UV LED) and their related technical contents were added;
- b) power efficiency ( $\eta_{PE}$ ) as part of electrical and optical characteristics were added;
- c) new measuring methods related to thermal resistance were added;
- d) hydrogen sulphide corrosion test was added to quality evaluation;
- e) some standards were added to the bibliography.

The text of this International Standard is based on the following documents:

FDIS	Report on voting
47E/745/FDIS	47E/752/RVD

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at [www.iec.ch/members\\_experts/refdocs](http://www.iec.ch/members_experts/refdocs). The main document types developed by IEC are described in greater detail at [www.iec.ch/standardsdev/publications](http://www.iec.ch/standardsdev/publications).

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- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

## SEMICONDUCTOR DEVICES –

### Part 5-6: Optoelectronic devices – Light emitting diodes

#### 1 Scope

This part of IEC 60747 specifies the terminology, the essential ratings and characteristics, the measuring methods and the quality evaluations of light emitting diodes (LEDs) for general industrial applications such as signals, controllers, sensors, etc.

LEDs for lighting applications are out of the scope of this part of IEC 60747.

LEDs are classified as follows:

- a) LED package;
- b) LED flat illuminator;
- c) LED numeric display and alpha-numeric display;
- d) LED dot-matrix display;
- e) infrared-emitting diode (IR LED);
- f) ultraviolet-emitting diode (UV LED).

LEDs with a heat spreader or having a terminal geometry that performs the function of a heat spreader are within the scope of this part of IEC 60747.

An integration of LEDs and controlgears, integrated LED modules, semi-integrated LED modules, integrated LED lamps or semi-integrated LED lamps, are out of the scope of this part of IEC 60747.

#### 2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60051 (all parts), *Direct acting indicating analogue electrical measuring instruments and their accessories*

IEC 60068-2-17, *Basic environmental testing procedures – Part 2-17: Tests – Test Q: Sealing*

IEC 60068-2-30, *Environmental testing – Part 2-30: Tests – Test Db: Damp heat, cyclic (12 h + 12 h cycle)*

IEC 60747-5-13, *Semiconductor devices – Part 5-13: Optoelectronic devices – Hydrogen sulphide corrosion test for LED packages*

IEC 60749-6, *Semiconductor devices – Mechanical and climatic test methods – Part 6: Storage at high temperature*

IEC 60749-10, *Semiconductor devices – Mechanical and climatic test methods – Part 10: Mechanical shock*